ANTREX Electronics

Electronic Components Sourcing Information

Product Reference Information

Part Number:	MMO62-16IO6
Manufacturer:	Vishay General Semiconductor - Diodes Division
Package:	MAGN-A-PAK
Availability:	Please confirm with sales

Product Page:

https://antrexco.com/product/details/vishay-general-semiconductor-diodes-division mmo62-16io6.html

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Contact Information

Email: info@antrexco.com

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Website: https://antrexco.com

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New & Original Components

Supplier verification and packaging condition review

CoC / RoHS / REACH documents available on request

Secure sourcing support for OEM / EMS projects

Note:

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.

SCR/SCR and SCR/Diode (MAGN-A-PAK Power Modules), 170 A, 250 A

MAGN-A-PAK

FEATURES

- High voltage
- Electrically isolated base plate
- 3500 V_{RMS} isolating voltage
- Industrial standard package
- Simplified mechanical designs, rapid assembly
- High surge capability
- Large creepage distances
- UL approved file E78996
- Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

RoHS COMPLIANT

PRIMARY CHARACTERISTICS	
$I_{T(AV)}$	170 A, 250 A
Type	Modules - thyristor, standard
Package	MAGN-A-PAK

DESCRIPTION

This VSK series of MAGN-A-PAK modules uses high voltage power thyristor/thyristor and thyristor/diode in seven basic configurations. The semiconductors are electrically isolated from the metal base, allowing common heatsinks and compact assemblies to be built. They can be interconnected to form single phase or three phase bridges or as AC-switches when modules are connected in anti-parallel mode. These modules are intended for general purpose applications such as battery chargers, welders, motor drives, UPS, etc.

MAJOR RATINGS AND CHARACTERISTICS				
SYMBOL	CHARACTERISTICS	VSK.170..	VSK.250..	UNITS
$I_{T(AV)}$	85 °C	170	250	A
$I_{T(RMS)}$		377	555	
I_{TSM}	50 Hz	5100	8500	
	60 Hz	5350	8900	
I^2t	50 Hz	131	361	kA^2s
	60 Hz	119	330	
$I^2\sqrt{t}$		1310	3610	$kA^2\sqrt{s}$
V_{DRM}/V_{RRM}		400 to 1600	400 to 2000	V
T_J	Range	-40 to +130		°C

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS

TYPE NUMBER	VOLTAGE CODE	V_{RRM}/V_{DRM}, MAXIMUM REPETITIVE PEAK REVERSE AND OFF-STATE BLOCKING VOLTAGE V	V_{RSM}, MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I_{RRM}/I_{DRM} AT 130 °C MAXIMUM mA
VS-VSK.170-	04	400	500	50
	08	800	900	
	10	1000	1100	
	12	1200	1300	
	14	1400	1500	
	16	1600	1700	
VS-VSK.250-	04	400	500	50
	08	800	900	
	10	1000	1100	
	12	1200	1300	
	14	1400	1500	
	16	1600	1700	
	18	1800	1900	60
	20	2000	2100	

ON-STATE CONDUCTION

PARAMETER	SYMBOL	TEST CONDITIONS			VSK.170	VSK.250	UNITS
Maximum average on-state current at case temperature	$I_{T(AV)}$	180° conduction, half sine wave			170	250	A
					85	85	°C
Maximum RMS on-state current	$I_{T(RMS)}$	As AC switch			377	555	A
Maximum peak, one-cycle on-state non-repetitive, surge current	I_{TSM}	t = 10 ms	No voltage reapplied	Sinusoidal half wave, initial T_J = T_J maximum	5100	8500	
		t = 8.3 ms			5350	8900	
		t = 10 ms	100 % V_{RRM} reapplied		4300	7150	
		t = 8.3 ms			4500	7500	
Maximum I^2t for fusing	I^2t	t = 10 ms	No voltage reapplied		131	361	kA^2s
		t = 8.3 ms			119	330	
		t = 10 ms	100 % V_{RRM} reapplied		92.5	255	
		t = 8.3 ms			84.4	233	
Maximum $I^2\sqrt{t}$ for fusing	$I^2\sqrt{t}$	t = 0.1 ms to 10 ms, no voltage reapplied			1310	3610	$kA^2\sqrt{s}$
Low level value or threshold voltage	$V_{T(TO)1}$	(16.7 % x π x $I_{T(AV)}$ < I < π x $I_{T(AV)}$), T_J = T_J maximum			0.89	0.97	V
High level value of threshold voltage	$V_{T(TO)2}$	(I > π x $I_{T(AV)}$), T_J = T_J maximum			1.12	1.00	
Low level value on-state slope resistance	r_{t1}	(16.7 % x π x $I_{T(AV)}$ < I < π x $I_{T(AV)}$), T_J = T_J maximum			1.34	0.60	mΩ
High level value on-state slope resistance	r_{t2}	(I > π x $I_{T(AV)}$), T_J = T_J maximum			0.96	0.57	
Maximum on-state voltage drop	V_{TM}	I_{TM} = π x $I_{T(AV)}$, T_J = T_J maximum, 180° conduction, average power = $V_{T(TO)}$ x $I_{T(AV)}$ + r_f x $(I_{T(RMS)})^2$			1.60	1.44	V
Maximum holding current	I_H	Anode supply = 12 V, initial I_T = 30 A, T_J = 25 °C			500	500	mA
Maximum latching current	I_L	Anode supply = 12 V, resistive load = 1 Ω, gate pulse: 10 V, 100 µs, T_J = 25 °C			1000	1000	

SWITCHING

PARAMETER	SYMBOL	TEST CONDITIONS	VSK.170	VSK.250	UNITS
Typical delay time	t_d	T_J = 25 °C, gate current = 1 A dI_g/dt = 1 A/µs V_d = 0.67 % V_{DRM}	1.0		µs
Typical rise time	t_r		2.0		
Typical turn-off time	t_q	I_{TM} = 300 A; dI/dt = 15 A/µs; T_J = T_J maximum; V_R = 50 V; dV/dt = 20 V/µs; gate 0 V, 100 Ω	50 to 150		

BLOCKING

PARAMETER	SYMBOL	TEST CONDITIONS	VSK.170	VSK.250	UNITS
Maximum peak reverse and off-state leakage current	I_{RRM}, I_{DRM}	T_J = T_J maximum	50	60	mA
RMS insulation voltage	V_{INS}	50 Hz, circuit to base, all terminals shorted, 25 °C, 1 s	3000		V
Critical rate of rise of off-state voltage	dV/dt	T_J = T_J maximum, exponential to 67 % rated V_{DRM}	1000		V/µs

TRIGGERING

PARAMETER	SYMBOL	TEST CONDITIONS		VSK.170	VSK.250	UNITS
Maximum peak gate power	P_{GM}	$t_p \le 5$ ms, T_J = T_J maximum		10.0		W
Maximum average gate power	$P_{G(AV)}$	f = 50 Hz, T_J = T_J maximum		2.0		
Maximum peak gate current	+ I_{GM}	$t_p \le 5$ ms, T_J = T_J maximum		3.0		A
Maximum peak negative gate voltage	- V_{GT}	$t_p \le 5$ ms, T_J = T_J maximum		5.0		V
Maximum required DC gate voltage to trigger	V_{GT}	T_J = -40 °C	Anode supply = 12 V, resistive load; Ra = 1 Ω	4.0		
		T_J = 25 °C		3.0		
		T_J = T_J maximum		2.0		
Maximum required DC gate current to trigger	I_{GT}	T_J = -40 °C	Anode supply = 12 V, resistive load; Ra = 1 Ω	350		mA
		T_J = 25 °C		200		
		T_J = T_J maximum		100		
Maximum gate voltage that will not trigger	V_{GD}	T_J = T_J maximum, rated V_{DRM} applied		0.25		V
Maximum gate current that willnot trigger	I_{GD}	T_J = T_J maximum, rated V_{DRM} applied		10.0		mA
Maximum rate of rise of turned-on current	dI/dt	T_J = T_J maximum, I_{TM} = 400 A, rated V_{DRM} applied		500		A/µs

THERMAL AND MECHANICAL SPECIFICATIONS

PARAMETER		SYMBOL	TEST CONDITIONS	VSK.170	VSK.250	UNITS
Junction operating and storage temperature range		T_J, T_{Stg}		-40 to +130		°C
Maximum thermal resistance, junction to case per junction		R_{thJC}	DC operation	0.17	0.125	K/W
Typical thermal resistance, case to heatsink per module		R_{thCS}	Mounting surface flat, smooth and greased	0.02	0.02	
Mounting torque ± 10 %	MAGN-A-PAK to heatsink		A mounting compound is recommended and the torque should be rechecked after a period of about 3 hours to allow for the spread of the compound.	4 to 6		Nm
	busbar to MAGN-A-PAK					
Approximate weight				500		g
				17.8		oz.
Case style				MAGN-A-PAK		

ΔR CONDUCTION PER JUNCTION											
DEVICES	SINUSOIDAL CONDUCTION AT T_J MAXIMUM					RECTANGULAR CONDUCTION AT T_J MAXIMUM					UNITS
	180°	120°	90°	60°	30°	180°	120°	90°	60°	30°	
VSK.170-	0.009	0.010	0.010	0.020	0.032	0.007	0.011	0.015	0.020	0.033	K/W
VSK.250-	0.009	0.010	0.014	0.020	0.032	0.007	0.011	0.015	0.020	0.033	

Note

- Table shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC

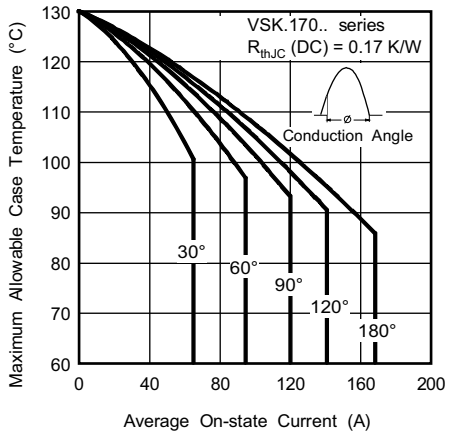


Fig. 1 - Current Ratings Characteristics

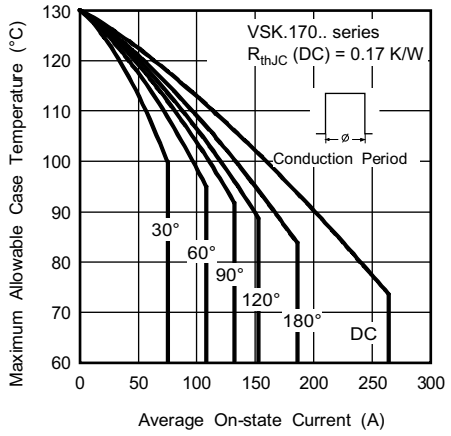


Fig. 2 - Current Ratings Characteristics

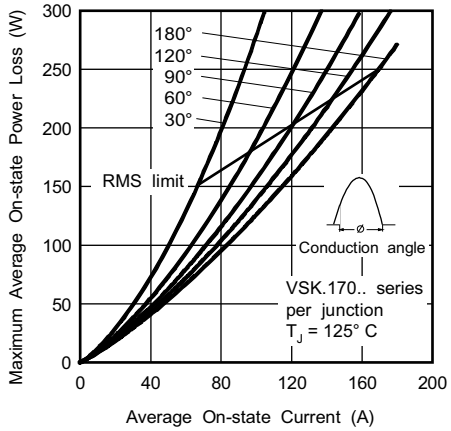


Fig. 3 - On-State Power Loss Characteristics

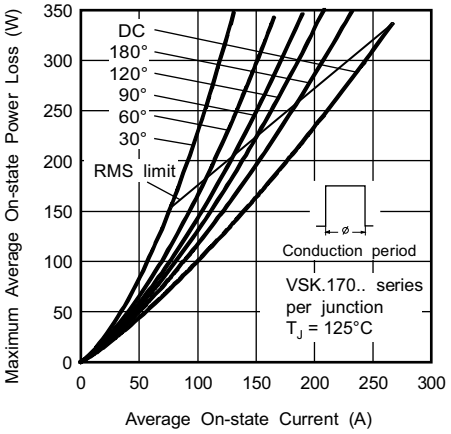


Fig. 4 - On-State Power Loss Characteristics

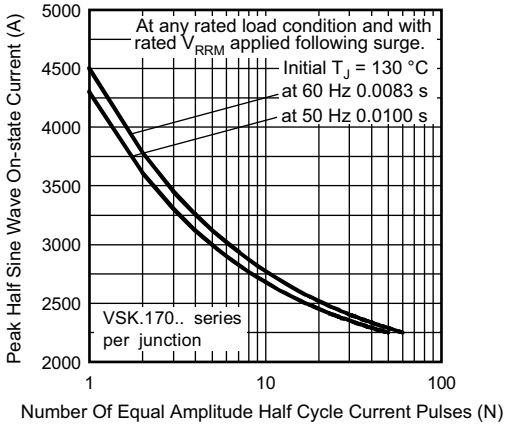


Fig. 5 - Maximum Non-Repetitive Surge Current

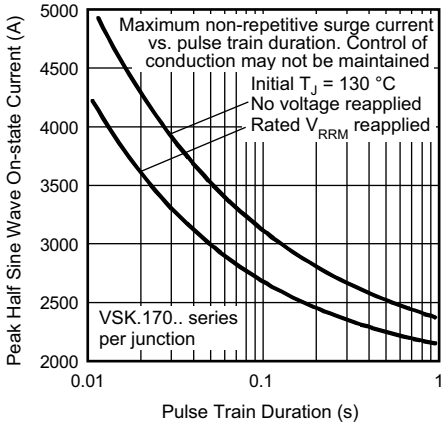


Fig. 6 - Maximum Non-Repetitive Surge Current

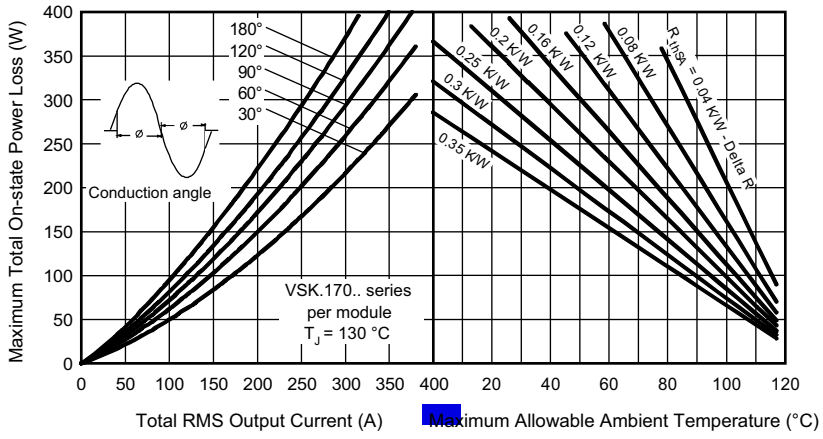


Fig. 7 - On-State Power Loss Characteristics

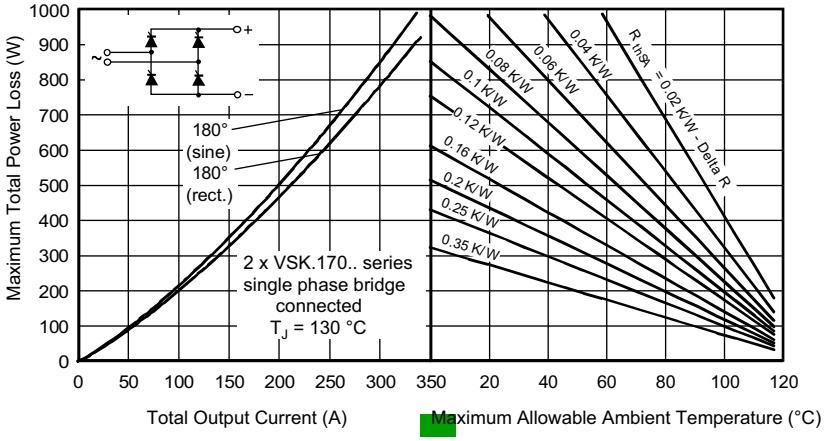


Fig. 8 - On-State Power Loss Characteristics

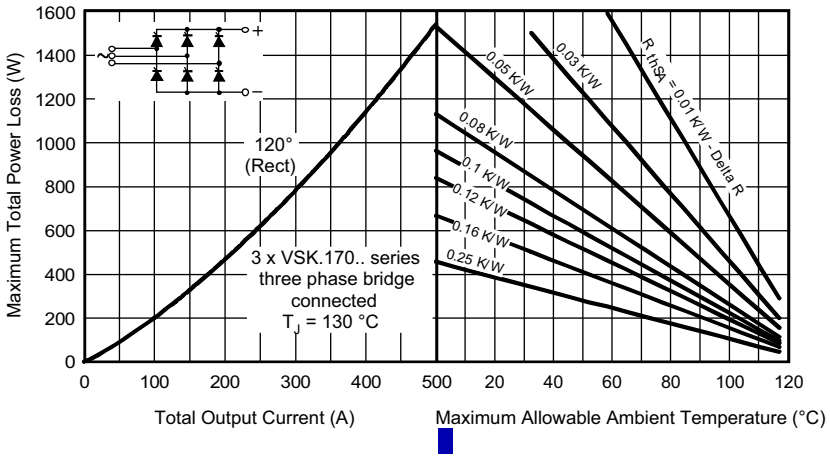


Fig. 9 - On-State Power Loss Characteristics

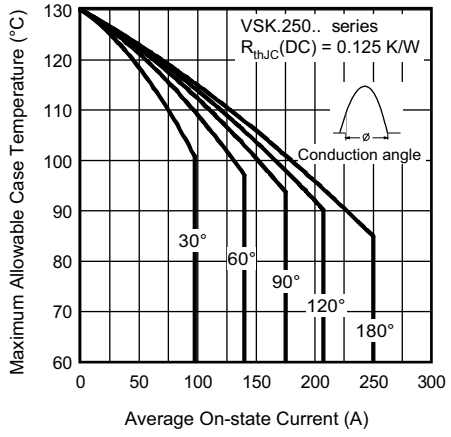


Fig. 10 - Current Ratings Characteristics

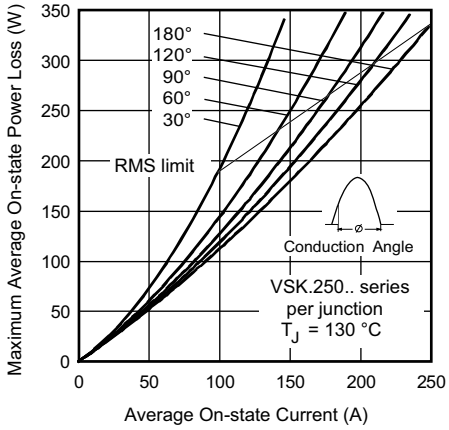


Fig. 12 - On-State Power Loss Characteristics

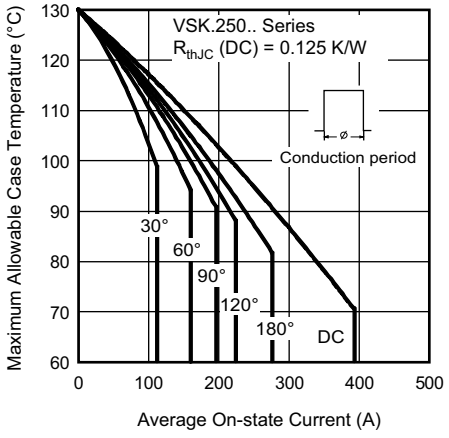


Fig. 11 - Current Ratings Characteristics

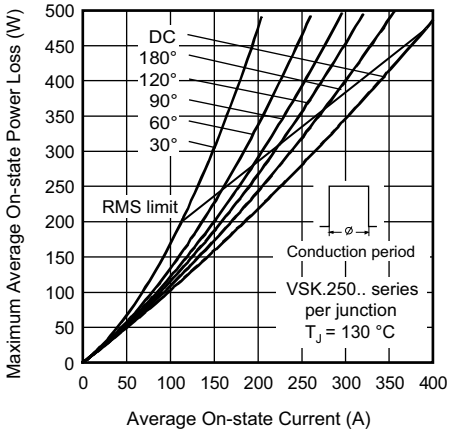


Fig. 13 - On-State Power Loss Characteristics

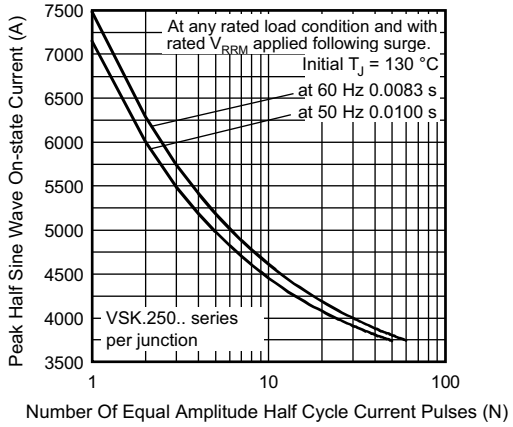


Fig. 14 - Maximum Non-Repetitive Surge Current

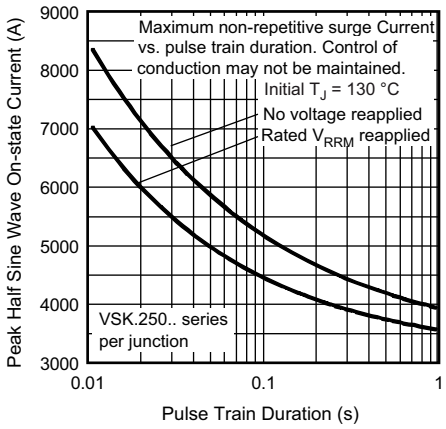


Fig. 15 - Maximum Non-Repetitive Surge Current

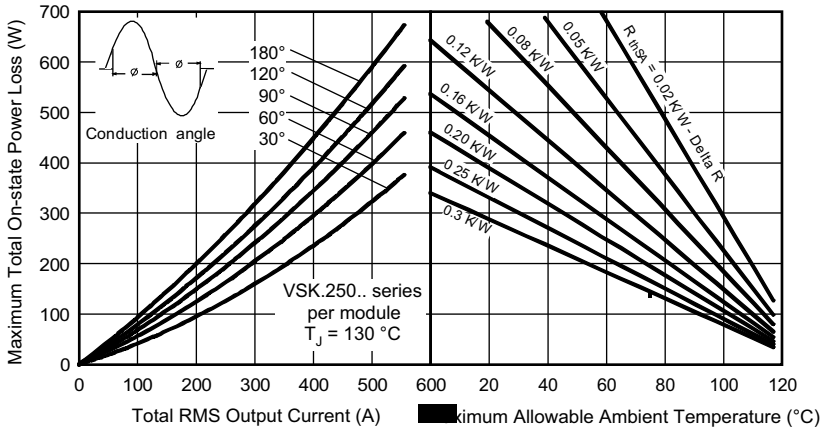


Fig. 16 - On-State Power Loss Characteristics

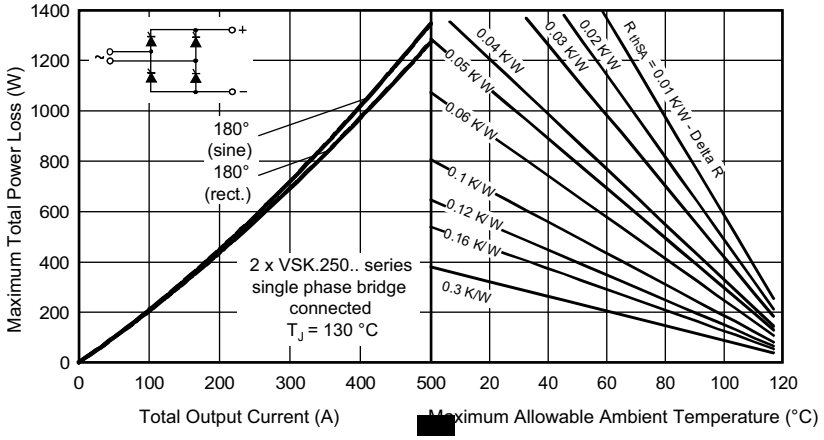


Fig. 17 - On-State Power Loss Characteristics

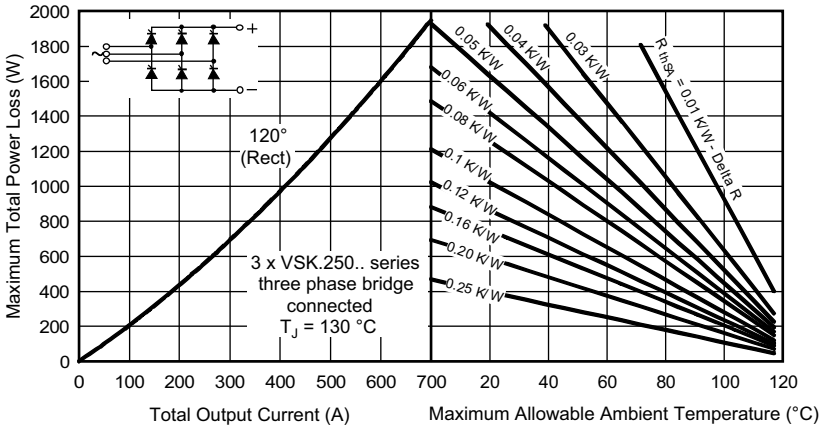


Fig. 18 - On-State Power Loss Characteristics

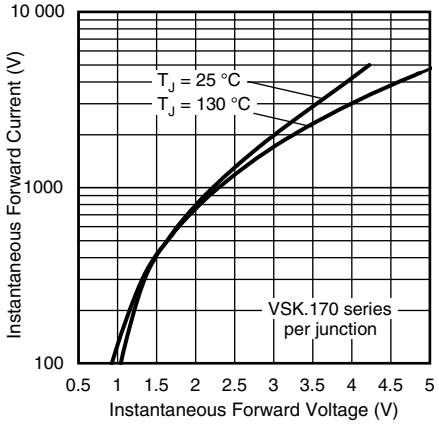


Fig. 19 - On-State Voltage Drop Characteristics

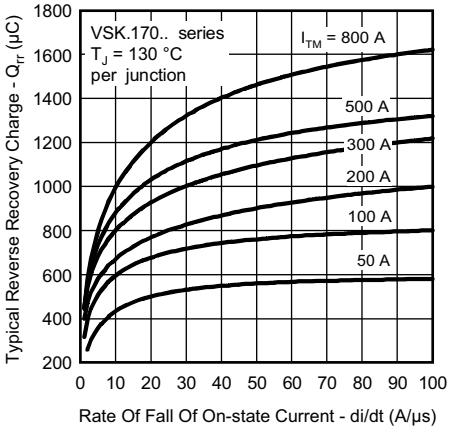


Fig. 21 - Reverse Recovery Charge Characteristics

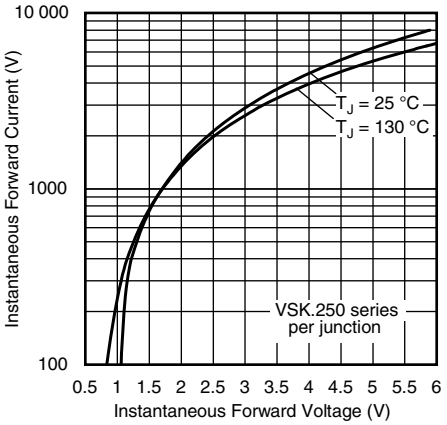


Fig. 20 - On-State Voltage Drop Characteristics

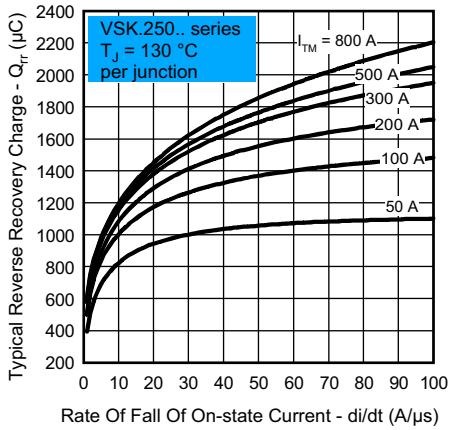


Fig. 22 - Reverse Recovery Charge Characteristics

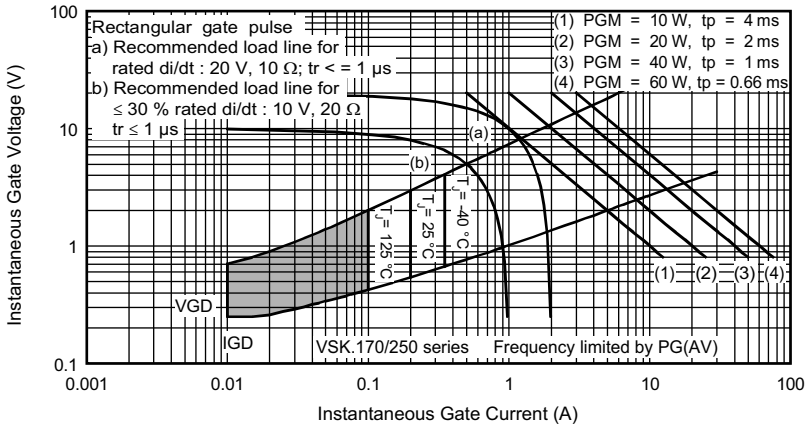


Fig. 23 - Gate Characteristics

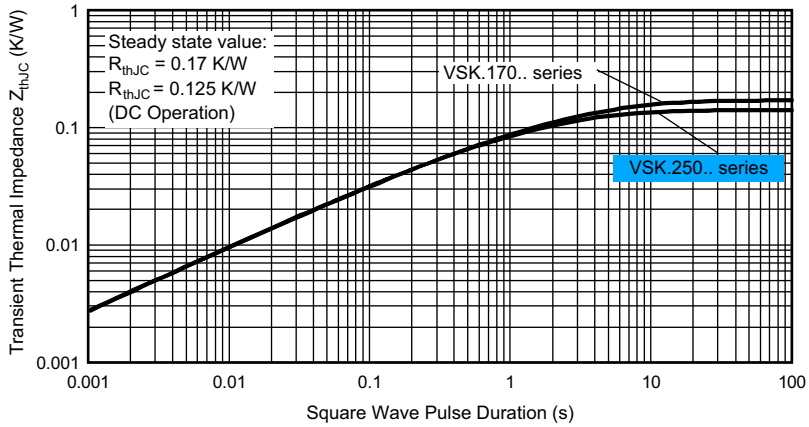


Fig. 24 - Thermal Impedance Z_{thJC} Characteristics

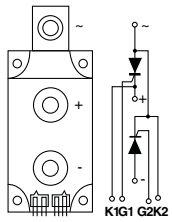
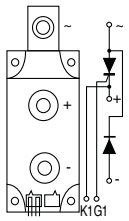
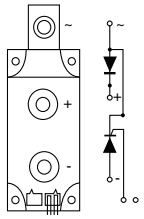
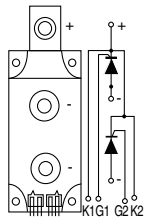
ORDERING INFORMATION TABLE

Device code	VS-VS	KT	250	-	20	PbF
	1	2	3		4	5

1	-	Vishay Semiconductors product
2	-	Circuit configuration (see dimensions - link at the end of datasheet)
3	-	Current rating
4	-	Voltage code x 100 = V_{RRM} (see Voltage Ratings table)
5	-	• None = standard production • PbF = lead (Pb)-free

Note

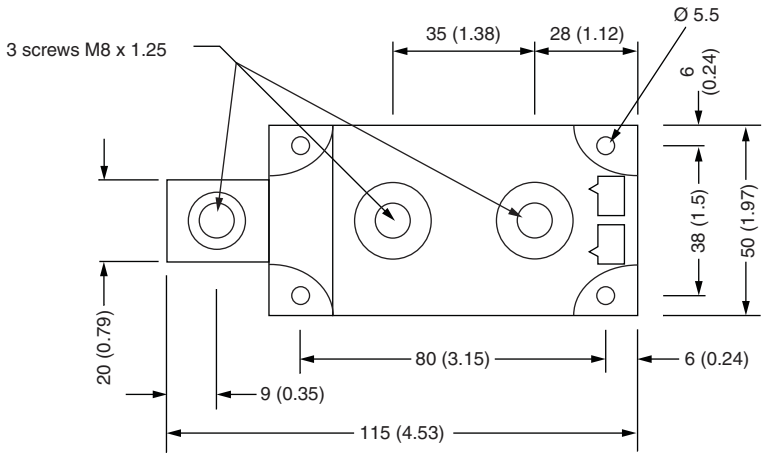
- To order the optional hardware go to www.vishay.com/doc?95172

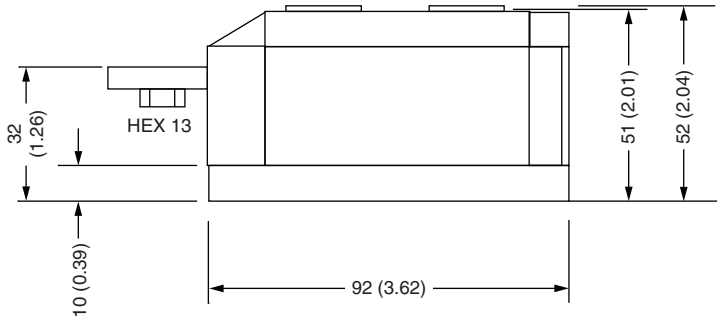
CIRCUIT CONFIGURATION		
CIRCUIT DESCRIPTION	**CIRCUIT CONFIGURATION CODE**	**CIRCUIT DRAWING**
Two SCRs doubler circuit	KT	VSKT...  Available up to 2000 V, contact factory for different requirement
SCR/diode doubler circuit, positive control	KH	VSKH...  Available up to 2000 V, contact factory for different requirement
SCR/diode doubler circuit, negative control	KL	VSKL...  Available up to 2000 V, contact factory for different requirement
Two SCRs common cathodes	KU	VSKU...  Available up to 1200 V, contact factory for different requirement

LINKS TO RELATED DOCUMENTS	
Dimensions	www.vishay.com/doc?95086

MAGN-A-PAK

DIMENSIONS in millimeters (inches)





Notes

- Dimensions are nominal
- Full engineering drawings are available on request
- UL identification number for gate and cathode wire: UL 1385
- UL identification number for package: UL 94 V-0

Disclaimer

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